#### TLC7628C DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER SLAS063B – APRIL 1989 – REVISED MARCH 2007

- Easy Microprocessor Interface
- On-Chip Data Latches
- Digital Inputs Are TTL-Compatible With 10.8-V to 15.75-V Power Supply
- Monotonic Over the Entire A/D Conversion Range
- Fast Control Signaling for Digital Signal Processor (DSP) Applications Including Interface With TMS320
- CMOS Technology

| KEY PERFORMANCE SPECIFICATIONS |         |  |  |  |  |  |  |  |  |
|--------------------------------|---------|--|--|--|--|--|--|--|--|
| Resolution                     | 8 bits  |  |  |  |  |  |  |  |  |
| Linearity Error                | 1/2 LSB |  |  |  |  |  |  |  |  |
| Power Dissipation              | 20 mW   |  |  |  |  |  |  |  |  |
| Settling Time                  | 100 ns  |  |  |  |  |  |  |  |  |
| Propagation Delay Time         | 80 ns   |  |  |  |  |  |  |  |  |

| DW OR N PACKAGE<br>(TOP VIEW) |    |    |                   |  |  |  |  |  |  |  |
|-------------------------------|----|----|-------------------|--|--|--|--|--|--|--|
| AGND                          | 1  | 20 | ] OUTB            |  |  |  |  |  |  |  |
| OUTA                          | 2  | 19 | ] RFBB            |  |  |  |  |  |  |  |
| RFBA                          | 3  | 18 | ] REFB            |  |  |  |  |  |  |  |
| REFA                          | 4  | 17 | ] V <sub>DD</sub> |  |  |  |  |  |  |  |
| DGND                          | 5  | 16 | ] WR              |  |  |  |  |  |  |  |
| DACA/DACB                     | 6  | 15 | ] CS              |  |  |  |  |  |  |  |
| (MSB) DB7                     | 7  | 14 | ] DB0 (LSB)       |  |  |  |  |  |  |  |
| DB6                           | 8  | 13 | ] DB1             |  |  |  |  |  |  |  |
| DB5                           | 9  | 12 | ] DB2             |  |  |  |  |  |  |  |
| DB4                           | 10 | 11 | ] DB3             |  |  |  |  |  |  |  |

#### description

The TLC7628C is a dual, 8-bit, digital-to-analog converter (DAC) designed with separate on-chip data latches and featuring exceptionally close DAC-to-DAC matching. Data are transferred to either of the two DAC data latches through a common, 8-bit input port. Control input DACA/DACB determines which DAC is loaded. The load cycle of this device is similar to the write cycle of a random-access memory, allowing easy interface to most popular microprocessor buses and output ports. Segmenting the high-order bits minimizes glitches during changes in the most significant bits, where glitch impulse is typically the strongest.

The TLC7628C operates from a 10.8-V to 15.75-V power supply and is TTL-compatible over this range. 2- or 4-quadrant multiplying makes this device a sound choice for many microprocessor-controlled gain-setting and signal-control applications.

The TLC7628C is characterized for operation from 0°C to +70°C.



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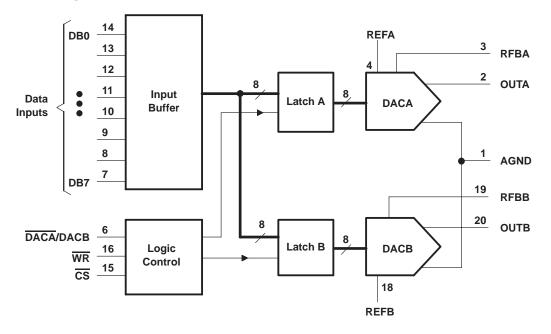
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SLAS063B - APRIL 1989 - REVISED MARCH 2007

#### functional block diagram



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

| Supply voltage range, V <sub>DD</sub> (to AGND or DGND)   |       |
|---|-------|
| Voltage between AGND and DGND<br>Input voltage range, V <sub>I</sub> (to DGND)  |       |
| Reference voltage range, V <sub>refA</sub> or V <sub>refB</sub> (to AGND)   | ±25 V |
| Feedback voltage range, V <sub>RFBA</sub> or V <sub>RFBB</sub> (to AGND)  |       |
| Output voltage range, V <sub>OA</sub> or V <sub>OB</sub> (to AGND)  |       |
| Operating free-air temperature range, T <sub>A</sub> : TLC7628C   | •     |
| Storage temperature range, T <sub>stg</sub>   |       |
| Case temperature for 10 seconds, T <sub>C</sub> : FN package<br>Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DW or N package |       |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



SLAS063B - APRIL 1989 - REVISED MARCH 2007

#### recommended operating conditions

|   |          | MIN  | NOM | MAX   | UNIT |
|---|----------|------|-----|-------|------|
| Supply voltage, V <sub>DD</sub>                           |          | 10.8 |     | 15.75 | V    |
| Reference voltage, V <sub>refA</sub> or V <sub>refB</sub> |          |      | ±10 |       | V    |
| High-level input voltage, V <sub>IH</sub>                 |          | 2.4  |     |       | V    |
| Low-level input voltage, VIL                              |          |      |     | 0.8   | V    |
| CS setup time, t <sub>SU(CS)</sub>                        |          | 50   |     |       | ns   |
| CS hold time, th(CS) (see Figure 1)                       |          | 0    |     |       | ns   |
| DAC select setup time, t <sub>SU(DAC)</sub> (see Figure   | e 1)     | 60   |     |       | ns   |
| DAC select hold time, th(DAC) (see Figure 1               | )        | 10   |     |       | ns   |
| Data bus input setup time $t_{su(D)}$ (see Figure         | : 1)     | 25   |     |       | ns   |
| Data bus input hold time $t_{h(D)}$ (see Figure 1         | )        | 10   |     |       | ns   |
| Pulse duration, WR low, tw(WR) (see Figure                | 1)       | 50   |     |       | ns   |
| Operating free-air temperature, TA                        | TLC7628C | 0    |     | +70   | °C   |

# electrical characteristics over recommended ranges of operating free-air temperature and $V_{DD}$ , $V_{refA} = V_{refB} = 10 V$ , $V_{OA}$ and $V_{OB}$ at 0 V (unless otherwise noted)

|          | PARAMETER                                      |                            | TEST CONDITIONS  |            | MIN  | MAX  | UNIT |  |
|----------|--|----------------------------|--|------------|------|------|------|--|
|          | Link lovel input evenent                       |                            |  | Full range |      | 10   |      |  |
| ΙΗ       | High-level input current                       |                            | $V_{I} = V_{DD}$   | 25°C       |      | 1    | μA   |  |
| L.       |  |                            | N/- 0  | Full range |      | -10  |      |  |
| ΊL       | Low-level input current                        |                            | V <sub>1</sub> = 0   | 25°C       |      | -1   | μA   |  |
|          | Reference input impedance REF<br>AGND          | A or REFB to               |  |            | 5    | 20   | kΩ   |  |
|          |  |                            | DAC data latch loaded with 00000000,                             | Full range |      | ±200 |      |  |
| ı.       | Ikg Output leakage current                     | OUTA $V_{refA} = \pm 10 V$ |  | 25°C       |      | ±50  | ~^   |  |
| 'kg      |  | OUTB                       | DAC data latch loaded with 00000000,                             | Full range |      | ±200 | nA   |  |
|          |  | OUTB                       | $V_{refB} = \pm 10 V$  | 25°C       |      | ±50  |      |  |
|          | Input resistance match (REFA to                | REFB)                      |  |            |      | ±1%  |      |  |
|          | DC supply consitivity Again/AV-                | -                          | $\Delta V_{DD} = \pm 5.9$  | Full range | 0.02 |      | %/%  |  |
|          | DC supply sensitivity $\Delta gain/\Delta V_D$ | D                          | $\Delta V_{DD} = \pm 5 \%$                                       | 25°C       |      | 0.01 | %)%  |  |
|          |  | Quiescent                  | All digital inputs at V <sub>IH</sub> min or V <sub>IL</sub> max |            | 2    |      |      |  |
| IDD      | Supply current                                 | Ctondby                    | All digital inputs at 0.1/ at 1/                                 | Full range |      | 0.5  | mA   |  |
|          |  | Standby                    | All digital inputs at 0 V or V <sub>DD</sub>                     | 25°C       | 0.1  |      |      |  |
|          |  | DB0-DB7                    |  |            |      | 10   |      |  |
| Ci       | C <sub>i</sub> Input capacitance               | WR, CS,<br>DACA/DACB       |  |            |      | 15   | pF   |  |
| <u> </u> | Output capacitance (OUTA, OU                   |                            | DAC data latches loaded with 00000000                            |            |      | 25   | pF   |  |
| Co       | Output capacitance (OUTA, OU                   |                            | DAC data latches loaded with 11111111                            |            |      | 60   | рг   |  |



SLAS063B - APRIL 1989 - REVISED MARCH 2007

operating characteristics over recommended ranges of operating free-air temperature and  $V_{DD}$ ,  $V_{refA} = V_{refB} = 10 \text{ V}$ ,  $V_{OA}$  and  $V_{OB}$  at 0 V (unless otherwise noted)

| PARAM  | IETER   |   | TEST CONDITIONS   |      |                              |              | UNIT    |  |
|--|---|---|---|------|------------------------------|--------------|---------|--|
| Linearity error  |   |   |   |      |                              | ±1/2         | LSB     |  |
| Settling time (to 1/2 L  | _SB)  | See Note 1                              |   |      | 100                          | ns           |         |  |
|  |   | Our Nation                              | Full range  |      |                              | ±3           | 1.00    |  |
| Gain error   |   | See Note 2                              | 25°C  |      |                              | ±2           | LSB     |  |
|  | REFA to OUTA  |   | Full range  |      |                              | -65          | 5       |  |
| AC feedthrough   | REFB to OUTB  | See Note 3                              | 25°C  |      |                              | -75          | dB      |  |
| Temperature coefficie  | mperature coefficient of gain   |   |   |      |                              | $\pm 0.0035$ | %FSR/°C |  |
| Propagation delay (from digital input to 90% of final analog output current) |   | See Note 4                              |   |      |                              | 80           | ns      |  |
| Channel-to-channel   | REFA to OUTB  | See Note 5                              | 25°C  |      | 80                           |              | 15      |  |
| isolation  | REFB to OUTA  | See Note 6                              | 25°C  |      | 80                           |              | dB      |  |
| Digital-to-analog glitc  | h impulse area  | Measured for cod<br>$T_A = 25^{\circ}C$ | Measured for code transition from 00000000 to 11111111, $T_{\mbox{\scriptsize A}}$ = 25°C |      | om 00000000 to 11111111, 330 |              | nV∙s    |  |
| Digital crosstalk  | alk Measured for code transition from 00000000 to 11111111,<br>$T_A = 25^{\circ}C$ 60 |   |   | nV∙s |                              |              |         |  |
| Harmonic distortion  |   | $V_i = 6 V, f = 1 kH$                   | Hz, $T_A = 25^{\circ}C$   |      | -85                          |              | dB      |  |

NOTES: 1. OUTA, OUTB load = 100  $\Omega$ , C<sub>ext</sub> = 13 pF;  $\overline{WR}$  and  $\overline{CS}$  at 0 V; DB0–DB7 at 0 V to V<sub>DD</sub> or V<sub>DD</sub> to 0 V.

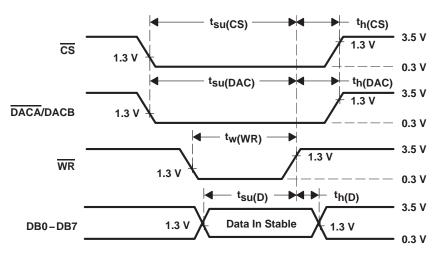
Gain error is measured using an internal feedback resistor. Nominal full scale range (FSR) = V<sub>ref</sub> – 1 LSB. Both DAC latches are loaded with 11111111.

3. Vref = 20 V peak-to-peak, 10-kHz sine wave

4.  $V_{refA} = V_{refB} = 10 \text{ V}$ ; OUTA/OUTB load = 100  $\Omega$ ,  $C_{ext} = 13 \text{ pF}$ ;  $\overline{WR}$  and  $\overline{CS}$  at 0 V; DB0–DB7 at 0 V to  $V_{DD}$  or  $V_{DD}$  to 0 V.

5.  $V_{refA} = 20 V \text{ peak-to-peak}, 10\text{-kHz sine wave}; V_{refB} = 0$ 

6.  $V_{refB} = 20 V peak-to-peak$ , 10-kHz sine wave;  $V_{refA} = 0$ 



For all input signals,  $t_f = t_f = 5$  ns (10% to 90% points).

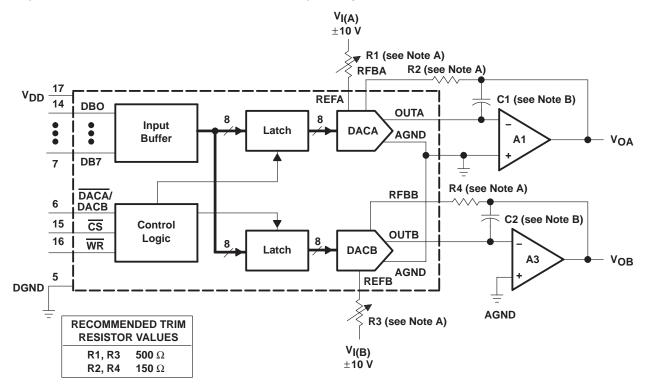
Figure 1. Setup and Hold Times



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#### **APPLICATION INFORMATION**

This device is capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2-quadrant and 4-quadrant multiplication are shown in Figures 2 and 3. Input coding for unipolar and bipolar operation are summarized in Tables 2 and 3, respectively.



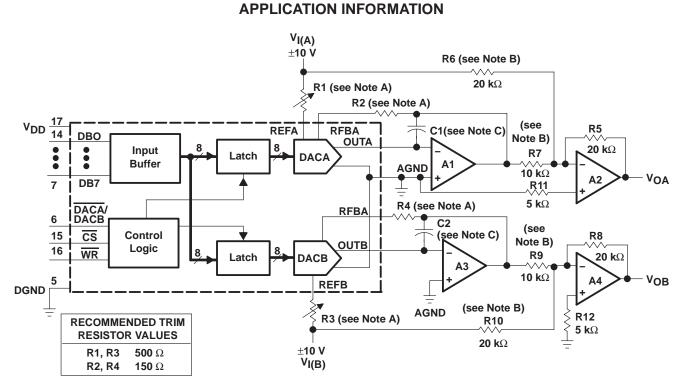
NOTES: A. R1, R2, R3, and R4 are used only if gain adjustment is required. See table for recommended values. Make gain adjustment with digital input of 255.

B. C1 and C2 phase compensation capacitors (10 pF to 15 pF) are required when using high-speed amplifiers to prevent ringing or oscillation.

Figure 2. Unipolar Operation (2-Quadrant Multiplication)



SLAS063B – APRIL 1989 – REVISED MARCH 2007

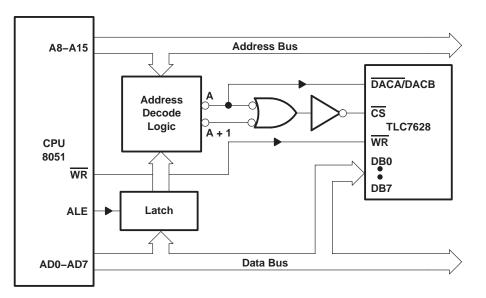


NOTES: A. R1, R2, R3, and R4 are used only if gain adjustment is required. See table for recommended values. Adjust R1 for V<sub>OA</sub> = 0 V with code 10000000 in DACA latch. Adjust R3 for V<sub>OB</sub> = 0 V with 10000000 in DACB latch.

B. Matching and tracking are essential for resistor pairs R6, R7, R9, and R10.

C. C1 and C2 phase compensation capacitors (10 pF to 15 pF) may be required if A1 and A3 are high-speed amplifiers.

Figure 3. Bipolar Operation (4-Quadrant Operation)

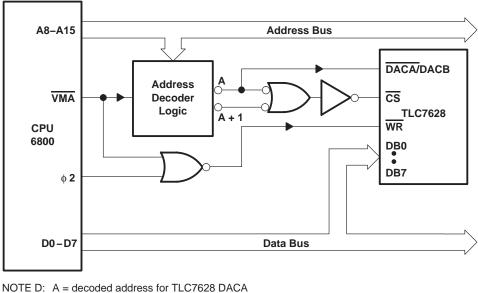


NOTE D: A = decoded address for TLC7628 DACA A + 1 = decoded address for TLC7628 DACB





SLAS063B - APRIL 1989 - REVISED MARCH 2007



### **APPLICATION INFORMATION**

NOTE D: A = decoded address for TLC7628 DACA A + 1 = decoded address for TLC7628 DACB

#### Figure 5. TLC7628 – 6800 Interface

#### voltage-mode operation

The current-multiplying DAC in the TLC7628C can be operated in a voltage mode. In the voltage mode, a fixed voltage is placed on the current output terminal. The analog output voltage is then available at the reference voltage terminal. An example of a current-multiplying DAC operating in voltage mode is shown in Figure 6. The relationship between the fixed input voltage and the analog output voltage is given by the following equation:

Analog output voltage = fixed input voltage (D/256)

where D = the digital input. In voltage-mode operation, these devices meet the following specification:

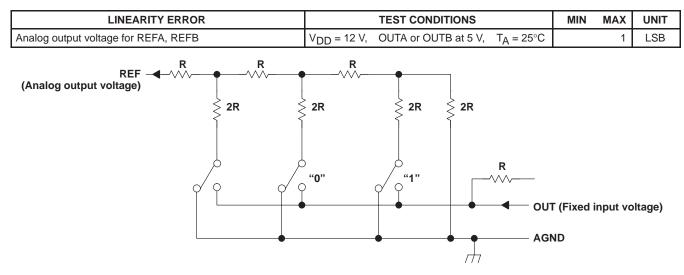


Figure 6. Current-Multiplying DAC Operating in Voltage Mode



SLAS063B - APRIL 1989 - REVISED MARCH 2007

### **PRINCIPLES OF OPERATION**

This device contains two, identical, 8-bit, multiplying DACs: DACA and DACB. Each DAC consists of an inverted R-2R ladder, analog switches, and input data latches. Binary-weighted currents are switched between the DAC output and AGND, thus maintaining a constant current in each ladder leg independent of the switch state. Most applications require only the addition of an external operational amplifier and voltage reference. A simplified D/A circuit for DACA or DACB with all digital inputs low is shown in Figure 7.

Figure 8 shows the DACA or DACB equivalent circuit. Both DACs share the analog ground terminal 1 (AGND). With all digital inputs high, the reference current flows to OUTA. A small leakage current ( $I_{Ikg}$ ) flows across internal junctions, and as with most semiconductor devices, doubles every 10°C. The C<sub>0</sub> is caused by the parallel combination of the NMOS switches and has a value that depends on the number of switches connected to the output. The range of C<sub>0</sub> is 25 pF to 60 pF maximum. The equivalent output resistance ( $r_0$ ) varies with the input code from 0.8R to 3R where R is the nominal value of the ladder resistor in the R-2R network.

The TLC7628C interfaces to a microprocessor through the data bus,  $\overline{CS}$ ,  $\overline{WR}$ , and  $\overline{DACA/DACB}$  control signals. When  $\overline{CS}$  and  $\overline{WR}$  are both low, the analog output on this device, specified by the  $\overline{DACA/DACB}$  control line, responds to the activity on the DB0–DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the  $\overline{CS}$  signal or  $\overline{WR}$  signal goes high, the data on the DB0–DB7 inputs are latched until the  $\overline{CS}$  and  $\overline{WR}$  signals go low again. When  $\overline{CS}$  is high, the data inputs are disabled, regardless of the state of the  $\overline{WR}$  signal.

The digital inputs of the TLC7628C provides TTL compatibility when operated from a supply voltage of 10.8 V to 15.75 V.

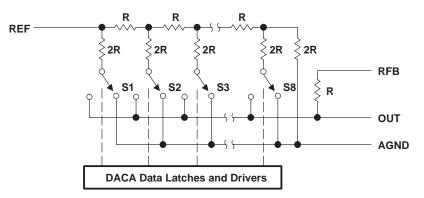
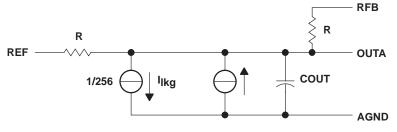


Figure 7. Simplified Functional Circuit for DACA or DACB



Latch A or Latch B Loaded With 1111111

Figure 8. TLC7628 Equivalent Circuit for DACA or DACB



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### **PRINCIPLES OF OPERATION**

#### Table 1. Mode Selection Table

| DACA/DACB | CS | WR | DACA  | DACB  |
|-----------|----|----|-------|-------|
| L         | L  | L  | Write | Hold  |
| Н         | L  | L  | Hold  | Write |
| Х         | н  | Х  | Hold  | Hold  |
| Х         | Х  | Н  | Hold  | Hold  |

L = low level, H = high level, X = don't care

#### Table 2. Unipolar Binary Code

| DAC LATCH CONTENTS<br>(see Note 7) | ANALOG OUTPUT                   |
|------------------------------------|---------------------------------|
| MSB LSB                            |                                 |
| 1111111                            | –VI (255/256)                   |
| 1000001                            | –VI (129/256)                   |
| 1000000                            | $-V_{i}$ (128/256) = $-V_{i}/2$ |
| 01111111                           | –Vj (127/256)                   |
| 0000001                            | -VI (1/256)                     |
| 00000000                           | $-V_{  }(0/256) = 0$            |

#### Table 3. Bipolar (Offset Binary) Code

|      | CONTENTS<br>lote 8) | ANALOG OUTPUT             |
|------|---------------------|---------------------------|
| MSB  | LSB                 |                           |
| 1111 | 1111                | V <sub>I</sub> (127/128)  |
| 1000 | 0001                | Vj (1/128)                |
| 1000 | 0000                | 0 V                       |
| 0111 | 1111                | –VI (1/128)               |
| 0000 | 0001                | -VI (127/128)             |
| 0000 | 0000                | –V <sub>I</sub> (128/128) |

NOTES: 7.  $1 \text{ LSB} = (2 - 8) \text{V}_{\text{I}}$ 8.  $1 \text{ LSB} = (2 - 7) \text{V}_{\text{I}}$ 





#### **PACKAGING INFORMATION**

| Orderable part number | Status | Material type | Package   Pins | Package qty   Carrier | RoHS | Lead finish/  | MSL rating/        | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|----------------|-----------------------|------|---------------|--------------------|--------------|--------------|
|                       | (1)    | (2)           |                |                       | (3)  | Ball material | Peak reflow        |              | (6)          |
|                       |        |               |                |                       |      | (4)           | (5)                |              |              |
| TLC7628CDW            | Active | Production    | SOIC (DW)   20 | 25   TUBE             | Yes  | NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TLC7628C     |
| TLC7628CDW.A          | Active | Production    | SOIC (DW)   20 | 25   TUBE             | Yes  | NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TLC7628C     |
| TLC7628CDWR           | Active | Production    | SOIC (DW)   20 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TLC7628C     |
| TLC7628CDWR.A         | Active | Production    | SOIC (DW)   20 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TLC7628C     |
| TLC7628CN             | Active | Production    | PDIP (N)   20  | 20   TUBE             | Yes  | NIPDAU        | N/A for Pkg Type   | 0 to 70      | TLC7628CN    |
| TLC7628CN.A           | Active | Production    | PDIP (N)   20  | 20   TUBE             | Yes  | NIPDAU        | N/A for Pkg Type   | 0 to 70      | TLC7628CN    |

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

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<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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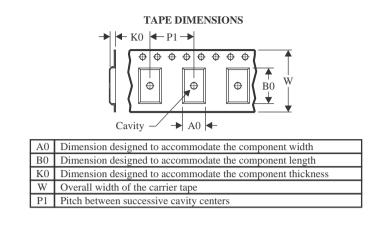
1-Jul-2025



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### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All | dimensions are | e nominal |
|------|----------------|-----------|
|      |                |           |

| Device      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TLC7628CDWR | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |



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# PACKAGE MATERIALS INFORMATION

23-May-2025



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLC7628CDWR | SOIC         | DW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |

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### TUBE



### - B - Alignment groove width

#### \*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLC7628CDW   | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| TLC7628CDW.A | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| TLC7628CN    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| TLC7628CN.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



# **DW0020A**



# **PACKAGE OUTLINE**

### SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



# DW0020A

# **EXAMPLE BOARD LAYOUT**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DW0020A

# **EXAMPLE STENCIL DESIGN**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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